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HEET

U.S. DEPARTMENT OF COMMERCE

Form PTO-1595

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Patent and Trademark Office

Docket No.: APM-01201

101294486

1. Name of conveying party(ies):

Hirokazu HONDA

Additional name(s) of conveying party(ies) attached?

Yes \_\_\_ No X

Nature of conveyance:

(X) Assignment

( ) Merger

( ) Security Agreement

( ) Change of Name

( ) Other:

Execution Date: February 10, 2000

2. Name and address of receiving party(ies)

Name: NEC Corporation

Internal Address:

Street Address: 7-1 Shiba 5 chome

Minato-ku, Tokyo JAPAN

Additional name(s) & address(es) attached? Yes \_\_\_ No X

Vertical stamp: 09/506139 PTO 02/17/00

4. Application number(s) or patent number(s):

09/506139

If this document is being filed together with a new application, the execution date of the applications is: February 10, 2000

A. Patent Application No.(s)

B. Patent No.(s)

Additional numbers attached? Yes \_\_\_ No X

5. Name and address of party to whom correspondence concerning document should be mailed:

6.

Name: Patent Group

Internal Address: Hutchins, Wheeler & Dittmar

Street Address: 101 Federal Street

City: Boston State: MA ZIP: 02110

6. Total number of applications and patents involved: 1

7. Total fee (37 CFR 3.41).....\$ \$40.00

X Enclosed

\_\_\_ Authorized to be charged to deposit account

8. Deposit account number:

(Attached duplicate copy of this page if paying by deposit account)

03/17/2000 DC0ATES 00000101 09506139

01 FC:581

Handwritten circled number: 40.00

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9. Statement and signature.

To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of the original document.

Donald W. Muirhead; 33,978

Name of Person Signing

Signature

February 17, 2000

Date

Total number of pages including cover sheet, attachments, and document: 2

Mail documents to be recorded with required covered sheet information to: Commissioner of Patents & Trademarks, Box Assignments Washington, D.C. 20231

ASSIGNMENT

WHEREAS, each of the Undersigned has developed certain inventions described in U.S. patent application titled SEMICONDUCTOR DEVICE AND METHOD OF FABRICATING THE SAME ( ) executed on even date herewith; ( ) executed on \_\_\_\_\_; ( ) now U.S. Application No. \_\_\_/\_\_\_\_\_ filed \_\_\_\_\_; and has full right to convey their entire interest, both legal and equitable, in and to said inventions free from all prior assignments, agreements, licenses, mortgages, security interests, or other encumbrances whatsoever; and


WHEREAS, NEC Corporation ("ASSIGNEE"), a Japanese corporation having executive offices at 7-1, Shiba 5-chome, Minato-ku, Tokyo, Japan, is desirous of acquiring the entire right, title and interest in and to said invention or inventions and any and all patents to be obtained therefor;

NOW, THEREFORE, in consideration of the sum of One Dollar (\$1.00) and other good and valuable consideration, the receipt and sufficiency of which are hereby acknowledged by each of the Undersigned, each of the Undersigned hereby sells, assigns and transfers unto said ASSIGNEE, its successors and assigns, their entire right, title and interest in and to said invention or inventions, as described in the aforesaid application and all applications resulting therefrom, including any and all divisionals, continuations, continuations in part, substitute applications, and reissues or extensions thereof; and all resulting patents;

AND each of the Undersigned hereby authorizes and requests the issuing authority to issue any and all patents on said application or applications to said ASSIGNEE or its successors and assigns; the Undersigned agree(s) that the attorney of record in said application shall hereinafter act on behalf of said ASSIGNEE;

AND, each of the Undersigned further agrees, without any further payment or compensation by said ASSIGNEE or its successors and assigns, to communicate to said ASSIGNEE, its representatives or agents or its successors and assigns, any facts relating to said invention or inventions including evidence for interference purposes or for other legal proceedings whenever requested; to testify in any interference or other legal proceedings, whenever requested; to execute and deliver, on request, all lawful papers required to make any of the foregoing provisions effective; and to generally do everything possible to aid said ASSIGNEE, its successors or assigns and nominees to secure, obtain and enforce proper patent protection for said invention or inventions in this or any foreign country;

Each of the undersigned hereby authorizes Foley, Hoag & Eliot, of One Post Office Square, Boston, MA 02109, to insert hereon any further identification information necessary or desirable for recordation of this document.

<u>Inventor(s)</u>	<u>Date Signed</u>	<u>Witnesses</u>
1. <u>Hirokazu Honda</u>  Name: HIROKAZU HONDA	<u>February 10, 2000</u>	<u>Hitoshi Uchi</u>
2. _____ Name: _____	_____	_____
3. _____ Name: _____	_____	_____
4. _____ Name: _____	_____	_____
5. _____ Name: _____	_____	_____
6. _____ Name: _____	_____	_____

( ) Additional inventors are being named on separately numbered sheets attached hereto.